



# PMN50EPE

30 V, P-channel Trench MOSFET

16 April 2018

Product data sheet

## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Trench MOSFET technology
- Logic-level compatible
- Very fast switching
- ElectroStatic Discharge (ESD) protection > 2 kV HBM

## 3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

## 4. Quick reference data

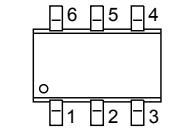
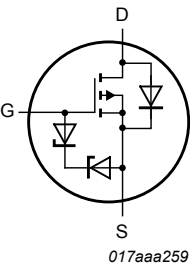
Table 1. Quick reference data

| Symbol                        | Parameter                        | Conditions                                                         | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|--------------------------------------------------------------------|-----|-----|-----|------|
| $V_{DS}$                      | drain-source voltage             | $T_j = 25\text{ °C}$                                               | -   | -   | -30 | V    |
| $V_{GS}$                      | gate-source voltage              |                                                                    | -20 | -   | 20  | V    |
| $I_D$                         | drain current                    | $V_{GS} = -10\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | -   | -6  | A    |
| <b>Static characteristics</b> |                                  |                                                                    |     |     |     |      |
| $R_{DS(on)}$                  | drain-source on-state resistance | $V_{GS} = -10\text{ V}; I_D = -4.6\text{ A}; T_j = 25\text{ °C}$   | -   | 35  | 45  | mΩ   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline                                                                                  | Graphic symbol                                                                                   |
|-----|--------|-------------|-----------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|
| 1   | D      | drain       | <br>TSOP6 (SOT457) | <br>017aaa259 |
| 2   | D      | drain       |                                                                                                     |                                                                                                  |
| 3   | G      | gate        |                                                                                                     |                                                                                                  |
| 4   | S      | source      |                                                                                                     |                                                                                                  |
| 5   | D      | drain       |                                                                                                     |                                                                                                  |
| 6   | D      | drain       |                                                                                                     |                                                                                                  |

6. Ordering information

Table 3. Ordering information

| Type number | Package |                                                  |         |
|-------------|---------|--------------------------------------------------|---------|
|             | Name    | Description                                      | Version |
| PMN50EPE    | TSOP6   | plastic surface-mounted package (TSOP6); 6 leads | SOT457  |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMN50EPE    | 3L           |

## 8. Limiting values

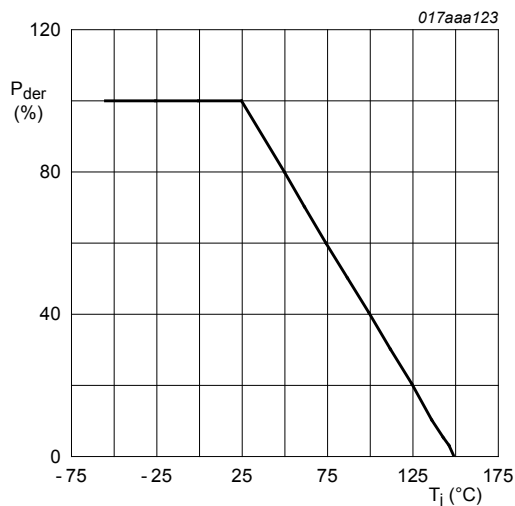
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                    | Parameter               | Conditions                                                     |     | Min | Max  | Unit |
|---------------------------|-------------------------|----------------------------------------------------------------|-----|-----|------|------|
| V <sub>DS</sub>           | drain-source voltage    | T <sub>j</sub> = 25 °C                                         |     | -   | -30  | V    |
| V <sub>GS</sub>           | gate-source voltage     |                                                                |     | -20 | 20   | V    |
| I <sub>D</sub>            | drain current           | V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s     | [1] | -   | -6   | A    |
|                           |                         | V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C              | [1] | -   | -4.6 | A    |
|                           |                         | V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 100 °C             | [1] | -   | -2.9 | A    |
| I <sub>DM</sub>           | peak drain current      | T <sub>amb</sub> = 25 °C; single pulse; t <sub>p</sub> ≤ 10 μs |     | -   | -19  | A    |
| P <sub>tot</sub>          | total power dissipation | T <sub>amb</sub> = 25 °C                                       | [2] | -   | 560  | mW   |
|                           |                         |                                                                | [1] | -   | 1.4  | W    |
|                           |                         | T <sub>sp</sub> = 25 °C                                        |     | -   | 6.25 | mW   |
| T <sub>j</sub>            | junction temperature    |                                                                |     | -55 | 150  | °C   |
| T <sub>amb</sub>          | ambient temperature     |                                                                |     | -55 | 150  | °C   |
| T <sub>stg</sub>          | storage temperature     |                                                                |     | -65 | 150  | °C   |
| <b>Source-drain diode</b> |                         |                                                                |     |     |      |      |
| I <sub>S</sub>            | source current          | T <sub>amb</sub> = 25 °C                                       | [1] | -   | -1.4 | A    |

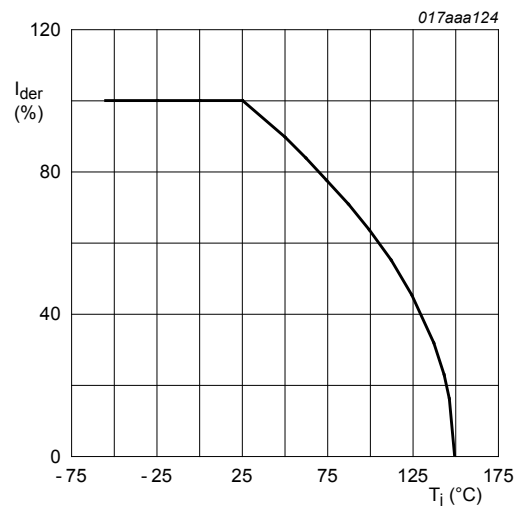
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ\text{C})}} \times 100 \%$$

**Fig. 1. Normalized total power dissipation as a function of junction temperature**



$$I_{der} = \frac{I_D}{I_{D(25^\circ\text{C})}} \times 100 \%$$

**Fig. 2. Normalized continuous drain current as a function of junction temperature**

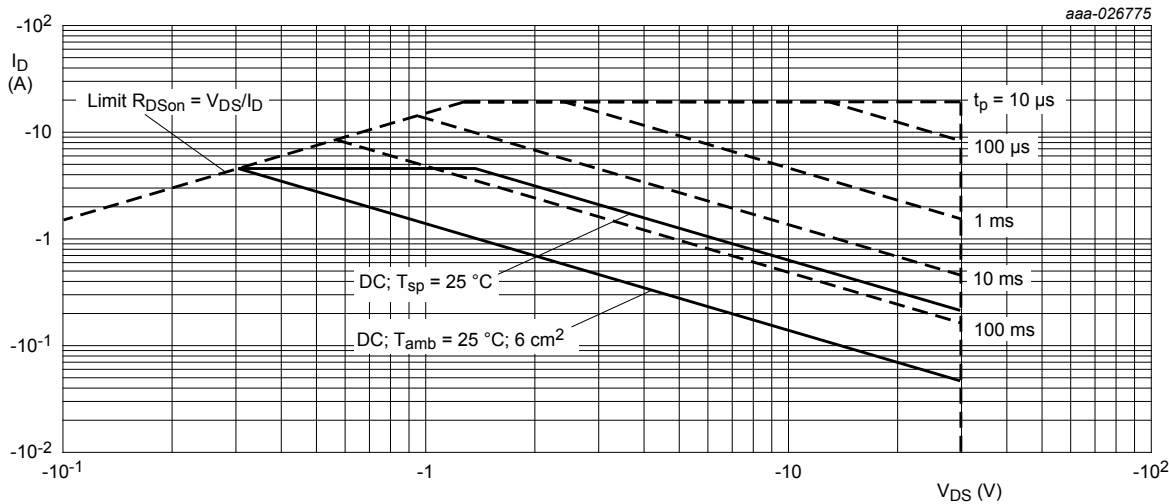


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol                | Parameter                                        | Conditions           |     | Min | Typ | Max | Unit |
|-----------------------|--------------------------------------------------|----------------------|-----|-----|-----|-----|------|
| R <sub>th(j-a)</sub>  | thermal resistance from junction to ambient      | in free air          | [1] | -   | 195 | 225 | K/W  |
|                       |                                                  |                      | [2] | -   | 78  | 90  | K/W  |
|                       |                                                  | in free air; t ≤ 5 s | [2] | -   | 55  | 63  | K/W  |
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point |                      |     | -   | 15  | 20  | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

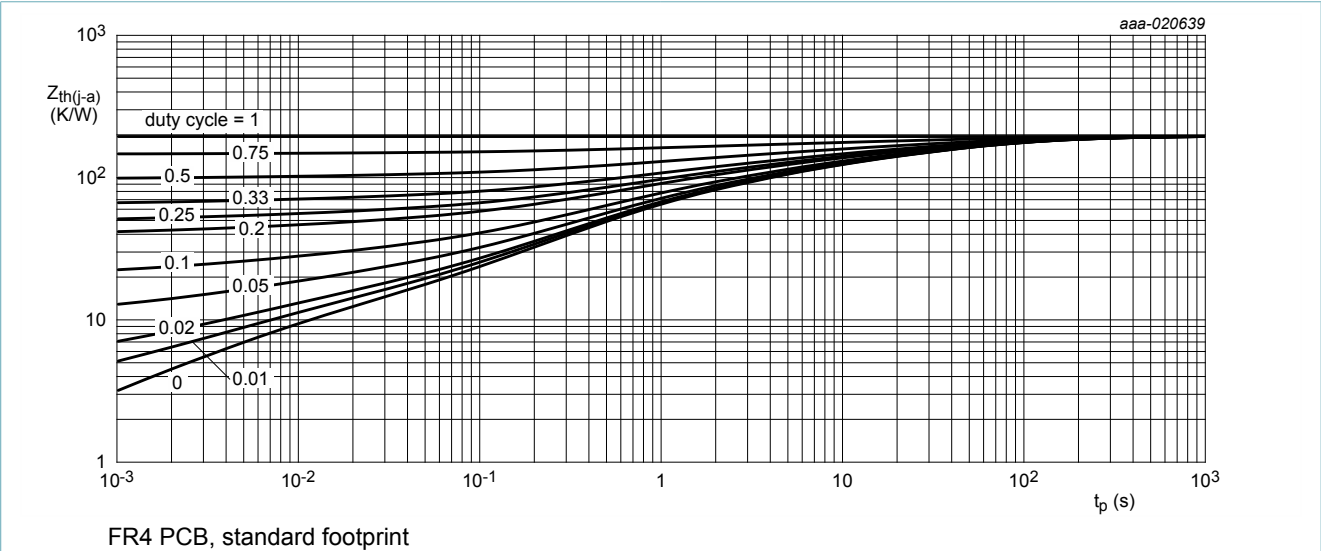


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

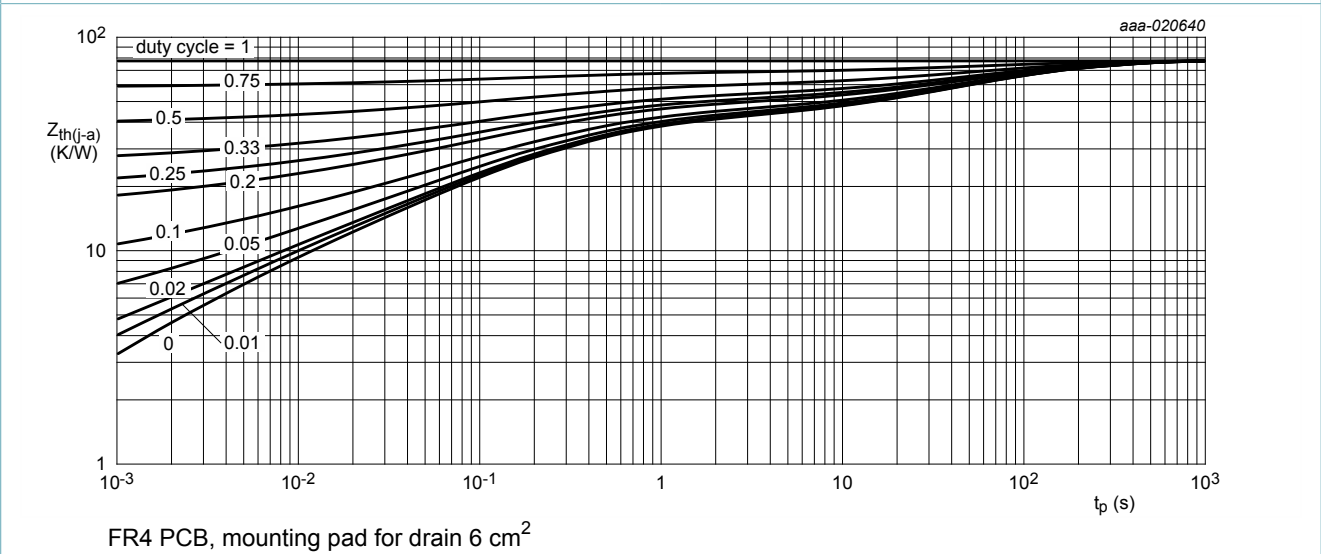


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

| Symbol                  | Parameter                        | Conditions                                                                                                                   |  | Min | Typ  | Max  | Unit |
|-------------------------|----------------------------------|------------------------------------------------------------------------------------------------------------------------------|--|-----|------|------|------|
| Static characteristics  |                                  |                                                                                                                              |  |     |      |      |      |
| V <sub>(BR)DSS</sub>    | drain-source breakdown voltage   | I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                      |  | -30 | -    | -    | V    |
| V <sub>GSth</sub>       | gate-source threshold voltage    | I <sub>D</sub> = -250 μA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 25 °C                                         |  | -1  | -2   | -3   | V    |
| I <sub>DSS</sub>        | drain leakage current            | V <sub>DS</sub> = -30 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                       |  | -   | -    | -1   | μA   |
| I <sub>GSS</sub>        | gate leakage current             | V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                        |  | -   | -    | 10   | μA   |
|                         |                                  | V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                       |  | -   | -    | -10  | μA   |
|                         |                                  | V <sub>GS</sub> = 10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                        |  | -   | -    | 2    | μA   |
|                         |                                  | V <sub>GS</sub> = -10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                       |  | -   | -    | -2   | μA   |
| R <sub>DSon</sub>       | drain-source on-state resistance | V <sub>GS</sub> = -10 V; I <sub>D</sub> = -4.6 A; T <sub>j</sub> = 25 °C                                                     |  | -   | 35   | 45   | mΩ   |
|                         |                                  | V <sub>GS</sub> = -10 V; I <sub>D</sub> = -4.6 A; T <sub>j</sub> = 150 °C                                                    |  | -   | 51   | 67   | mΩ   |
|                         |                                  | V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -3.6 A; T <sub>j</sub> = 25 °C                                                    |  | -   | 49   | 72   | mΩ   |
| g <sub>fs</sub>         | forward transconductance         | V <sub>DS</sub> = -10 V; I <sub>D</sub> = -4.6 A; T <sub>j</sub> = 25 °C                                                     |  | -   | 14.2 | -    | S    |
| R <sub>G</sub>          | gate resistance                  | f = 1 MHz                                                                                                                    |  | -   | 13   | -    | Ω    |
| Dynamic characteristics |                                  |                                                                                                                              |  |     |      |      |      |
| Q <sub>G(tot)</sub>     | total gate charge                | V <sub>DS</sub> = -15 V; I <sub>D</sub> = -4.2 A; V <sub>GS</sub> = -10 V; T <sub>j</sub> = 25 °C                            |  | -   | 12.8 | 20   | nC   |
| Q <sub>GS</sub>         | gate-source charge               |                                                                                                                              |  | -   | 2.2  | -    | nC   |
| Q <sub>GD</sub>         | gate-drain charge                |                                                                                                                              |  | -   | 2.2  | -    | nC   |
| C <sub>iss</sub>        | input capacitance                | V <sub>DS</sub> = -15 V; f = 1 MHz; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C                                            |  | -   | 793  | -    | pF   |
| C <sub>oss</sub>        | output capacitance               |                                                                                                                              |  | -   | 134  | -    | pF   |
| C <sub>rss</sub>        | reverse transfer capacitance     |                                                                                                                              |  | -   | 84   | -    | pF   |
| t <sub>d(on)</sub>      | turn-on delay time               | V <sub>DS</sub> = -15 V; I <sub>D</sub> = -4.2 A; V <sub>GS</sub> = -10 V; R <sub>G(ext)</sub> = 6 Ω; T <sub>j</sub> = 25 °C |  | -   | 6    | -    | ns   |
| t <sub>r</sub>          | rise time                        |                                                                                                                              |  | -   | 19   | -    | ns   |
| t <sub>d(off)</sub>     | turn-off delay time              |                                                                                                                              |  | -   | 36   | -    | ns   |
| t <sub>f</sub>          | fall time                        |                                                                                                                              |  | -   | 19   | -    | ns   |
| Source-drain diode      |                                  |                                                                                                                              |  |     |      |      |      |
| V <sub>SD</sub>         | source-drain voltage             | I <sub>S</sub> = -1.4 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C                                                       |  | -   | -0.8 | -1.2 | V    |

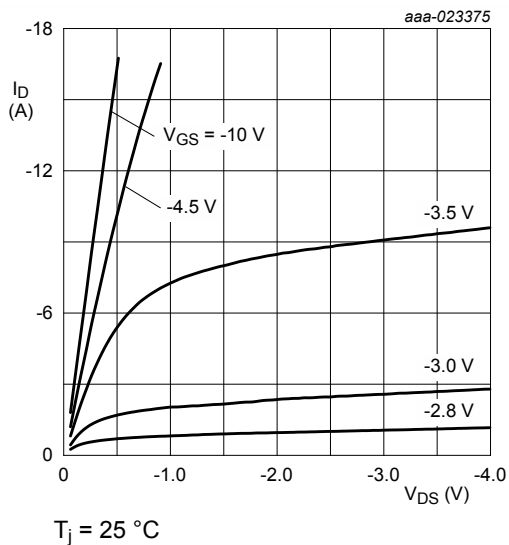


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

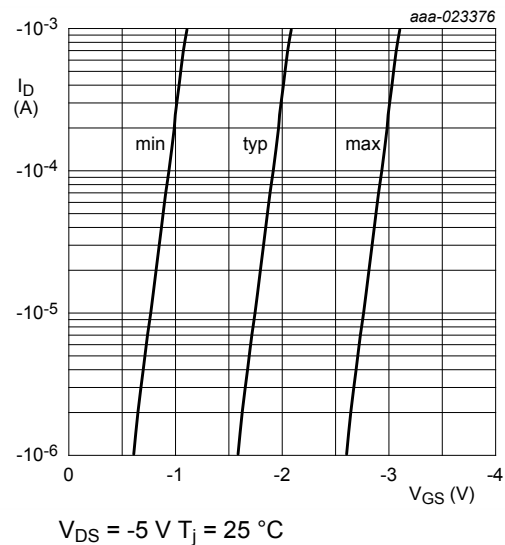


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

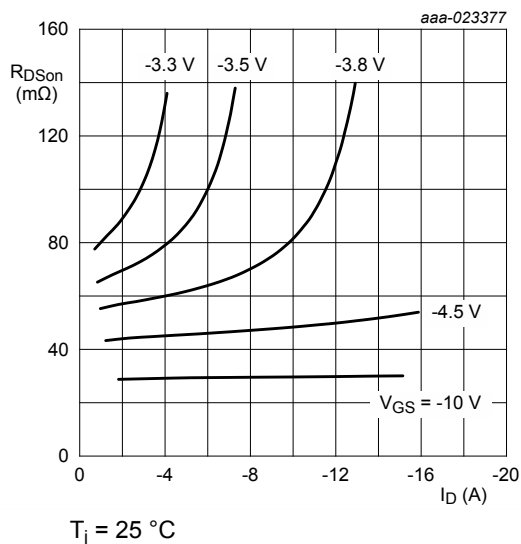


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

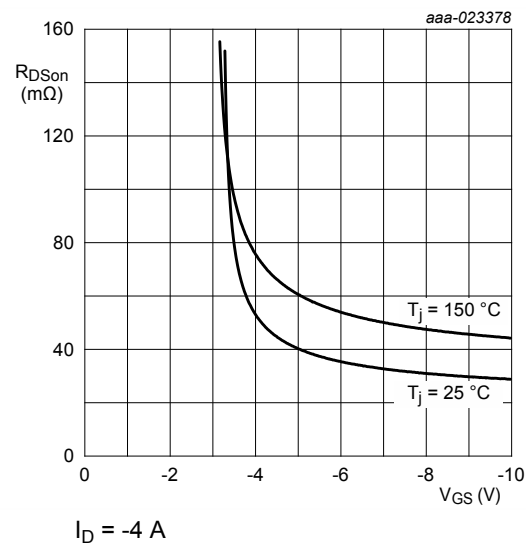


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

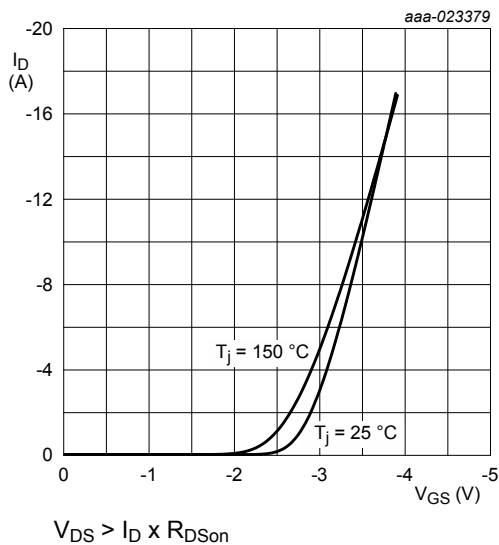


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

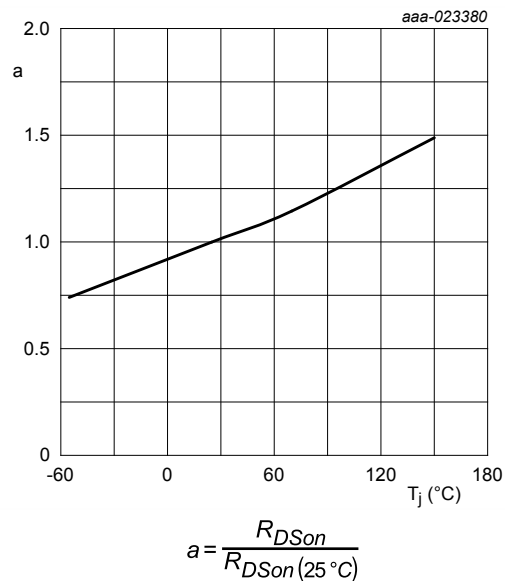


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

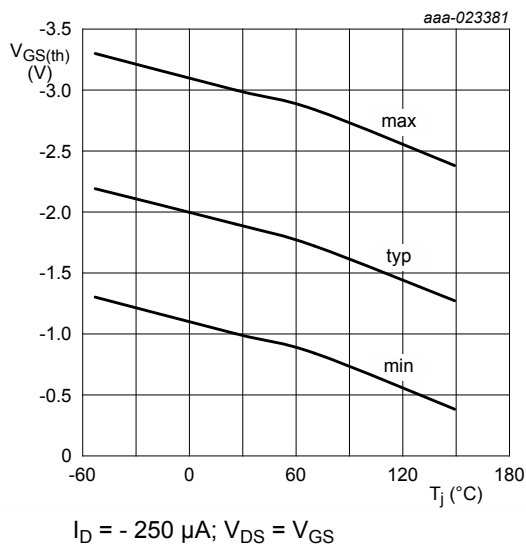


Fig. 12. Gate-source threshold voltage as a function of junction temperature

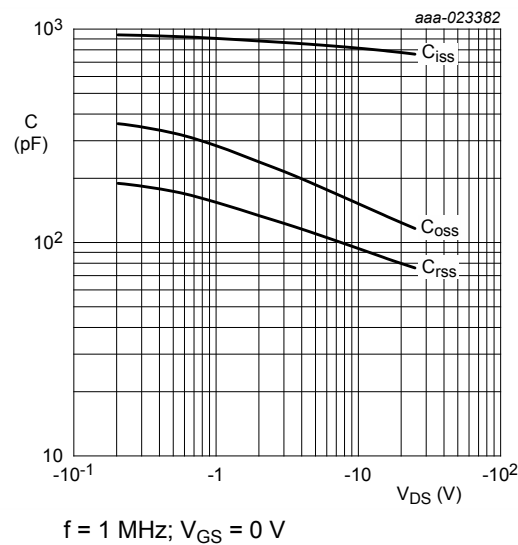


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

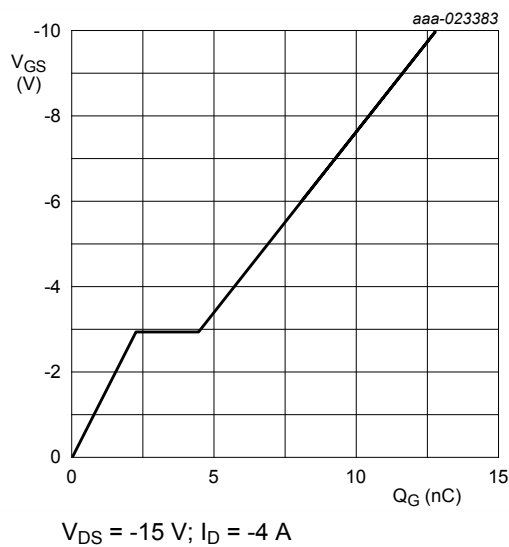


Fig. 14. Gate-source voltage as a function of gate charge; typical values

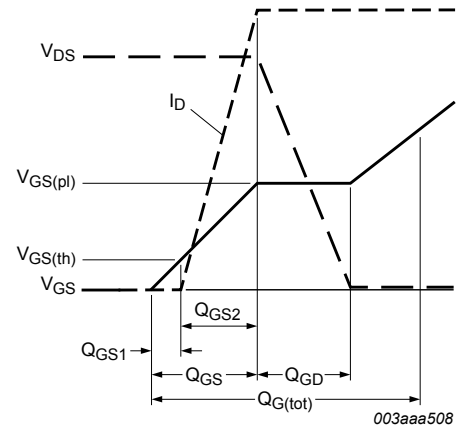


Fig. 15. Gate charge waveform definitions

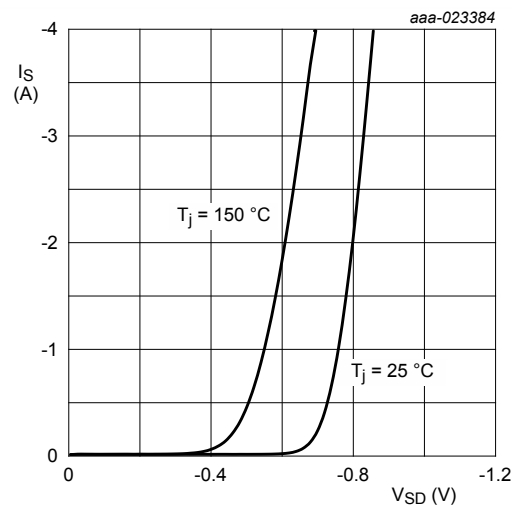
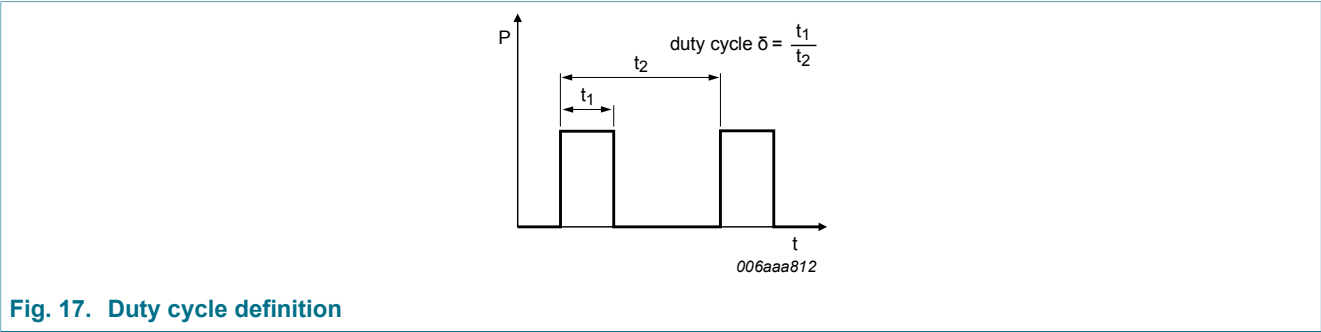
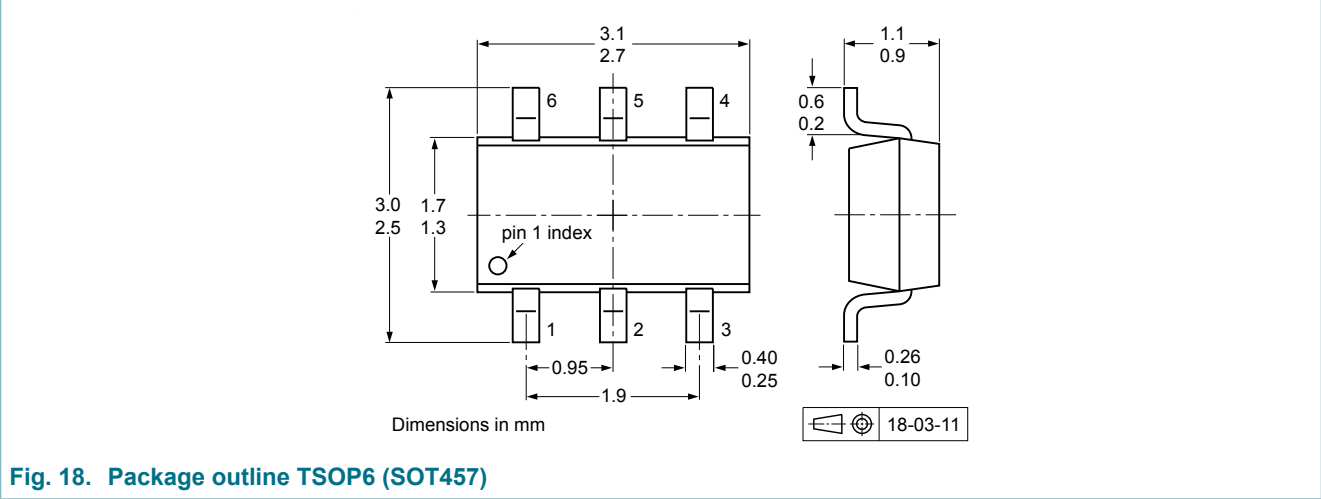


Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information



12. Package outline



13. Soldering

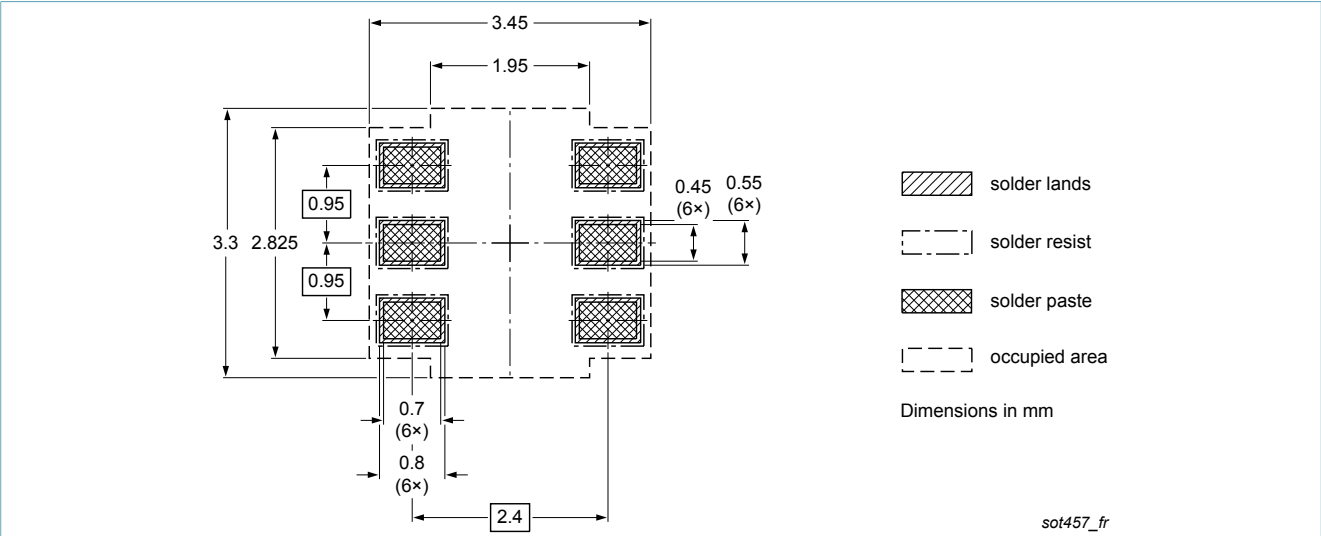


Fig. 19. Reflow soldering footprint for TSOP6 (SOT457)

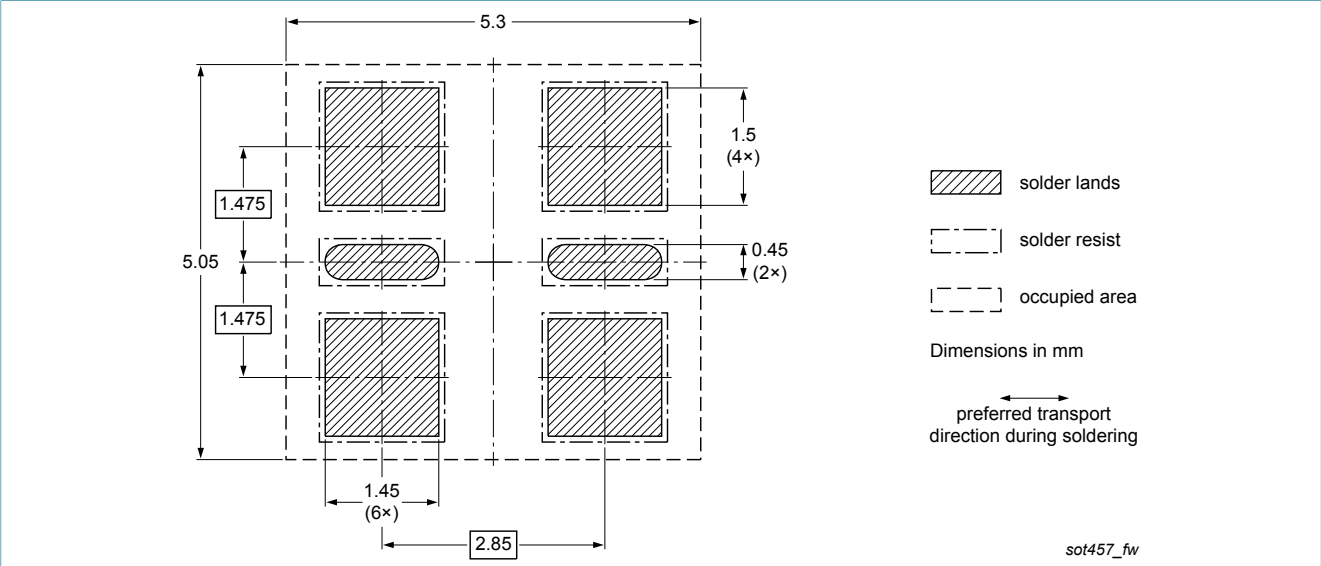


Fig. 20. Wave soldering footprint for TSOP6 (SOT457)

## 14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PMN50EPE v.1  | 20180416     | Product data sheet | -             | -          |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

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- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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